



## 30V/3.5A N-Channel Enhancement Mode MOSFET

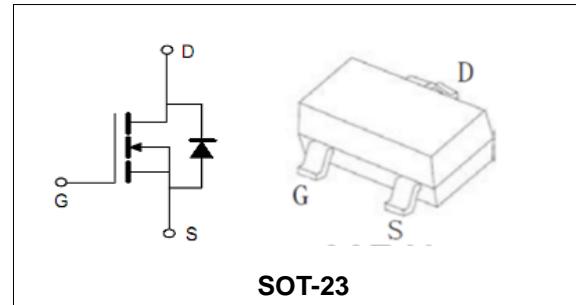
**Features**

- Advanced trench process technology
- High Density Cell Design For Ultra Low On-Resistance
- High Power and Current handing capability

BVDSS	30	V
ID	3.5	A
RDS(ON)@VGS=10V	29	mΩ
RDS(ON)@VGS=4.5V	44	mΩ

**Applications**

- Low Side Load Switch
- Battery Switch
- Optimized for Power Management Applications for Portable Products, such as Aeromodelling, Power bank, Brushless motor, Main board , and Others

**Order Information**

Product	Package	Marking	Reel Size	Reel	Carton
PT2306	SOT-23	A6SHB	7inch	3000PCS	180000PCS

**Absolute Maximum Ratings**

Symbol	Parameter	Rating	Unit	
<b>Common Ratings (TC=25°C Unless Otherwise Noted)</b>				
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	30	V	
V <sub>GS</sub>	Gate-Source Voltage	±20	V	
T <sub>J</sub>	Maximum Junction Temperature	150	°C	
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C	
I <sub>S</sub>	Diode Continuous Forward Current	TA =25°C	3.5	A
<b>Mounted on Large Heat Sink</b>				
I <sub>DM</sub>	Pulse Drain Current Tested (Silicon Limit) (Note1)	TA =25°C	16	A
I <sub>D</sub>	Continuous Drain current	TA =25°C	3.5	A
P <sub>D</sub>	Maximum Power Dissipation	TA =25°C	1.4	W
R <sub>θJA</sub>	Thermal Resistance Junction-to-Ambient (Note2)		357	°C/W

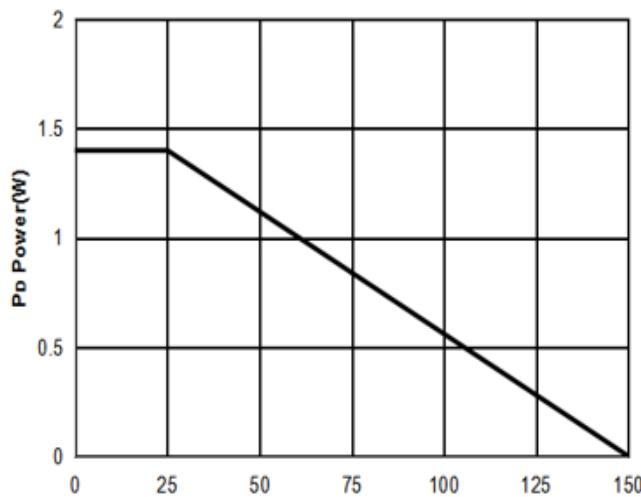
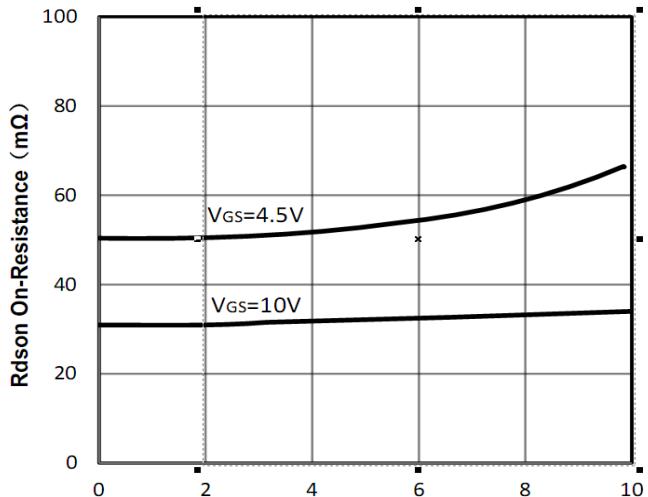
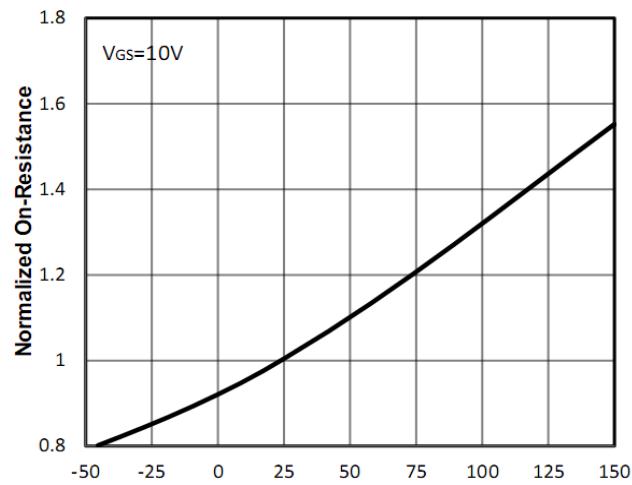
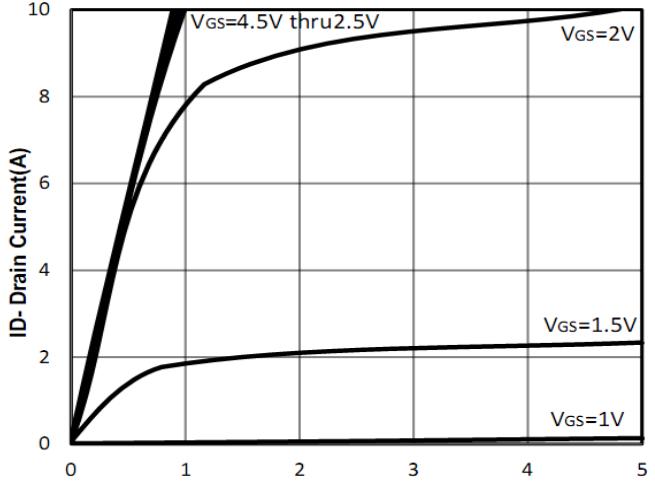
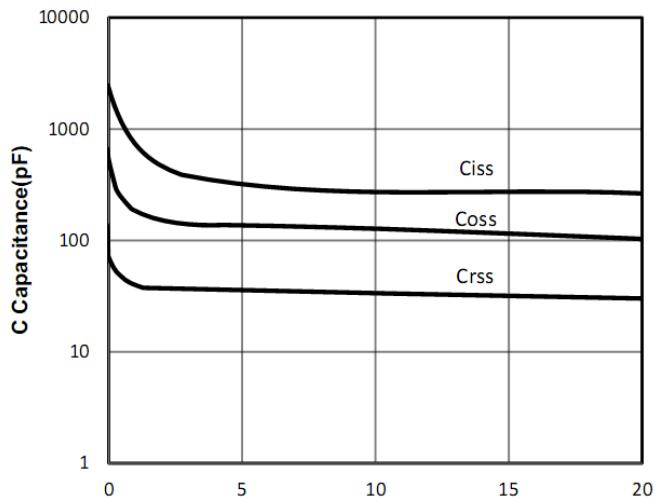
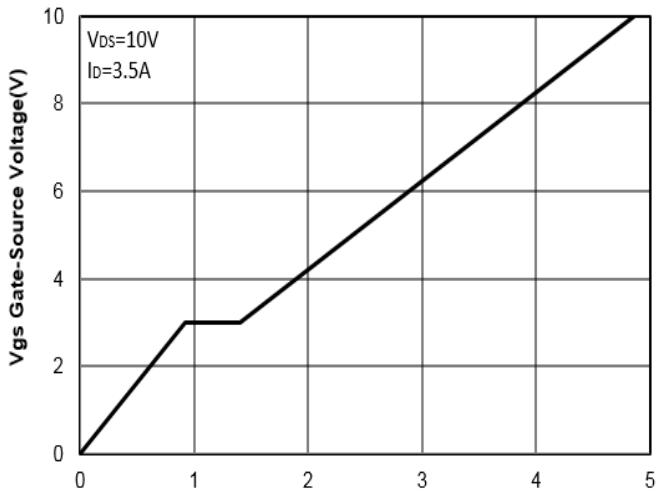


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Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ <math>T_J = 25^\circ C</math> (unless otherwise stated)</b>						
$V_{(BR)DSS}$	Drain- Source Breakdown Voltage	$V_{GS}=0V$ $ID=250\mu A$	30	--	--	V
$I_{DSS}$	Zero Gate Voltage Drain current	$V_{DS}=30V, V_{GS}=0V$	--	--	1	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	--	--	$\pm 100$	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, ID=250\mu A$	1	--	2.5	V
$R_{DS(ON)}$	Drain-Source On-State Resistance (Note3)	$V_{GS}=10V, ID=3.5A$	--	29	47	$m\Omega$
		$V_{GS}=4.5V, ID=2.8A$	--	44	63	$m\Omega$
<b>Dynamic Electrical Characteristics @ <math>T_J = 25^\circ C</math> (unless otherwise stated) (Note4)</b>						
$C_{iss}$	Input Capacitance	$V_{DS}= 8V,$ $V_{GS}=0V,$ $F=1MHz$	--	562	--	pF
$C_{oss}$	Output Capacitance		--	106	--	pF
$C_{rss}$	Reverse Transfer Capacitance		--	75	--	pF
$Q_g$	Total Gate Charge3	$V_{DS}= 10V,$ $ID= 3.5A,$ $V_{GS}= 4.5V$	--	4.86	--	nC
$Q_{gs}$	Gate-Source Charge		--	0.92	--	nC
$Q_{gd}$	Gate-Drain Charge		--	1.4	--	nC
<b>Switching Characteristics (Note4)</b>						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=15V,$ $ID=1A,$ $RG=6\Omega,$ $V_{GS}=10V$	--	9	--	nS
$t_r$	Turn-on Rise Time		--	7.5	--	nS
$t_{d(off)}$	Turn-off Delay Time		--	17	--	nS
$t_f$	Turn-off Fall Time		--	5.2	--	nS
<b>Source- Drain Diode Characteristics@ <math>T_J = 25^\circ C</math> (unless otherwise stated)</b>						
$V_{SD}$	Forward on voltage (Note3)	$IS=1.25A, V_{GS}=0V$	--	--	1.2	V

Note:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec
3. Pulse Test: pulse width  $\leq 300$  us, duty cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production testing.

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**Typical Characteristics**

**Figure1: TJ Junction Temperature (°C)**

**Figure2: ID Drain Current (A)**

**Figure3: TJ Junction Temperature (°C)**

**Figure4: VDS Drain-Source Voltage (V)**

**Figure5: VDS Drain-Source Voltage (V)**

**Figure6: Qg Gate Charge (nC)**

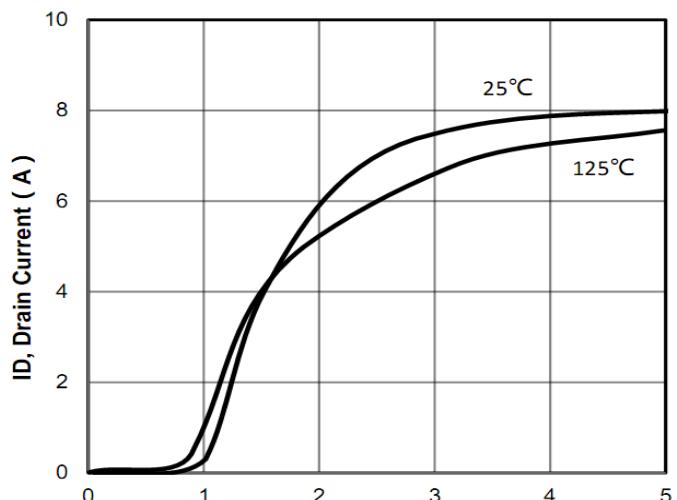
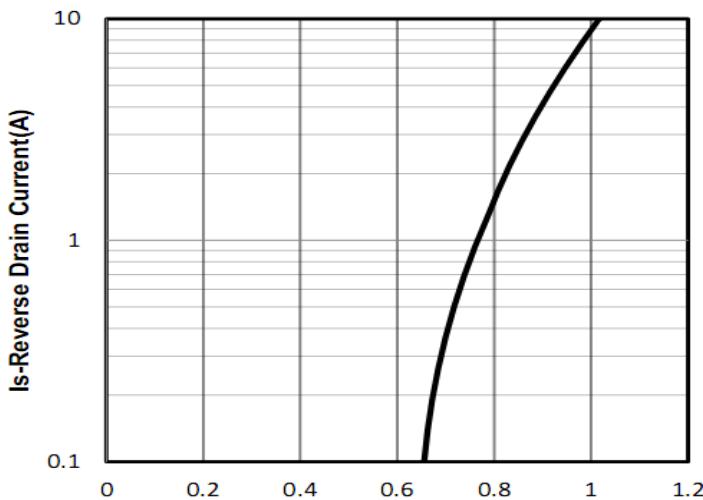
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Figure 7: V<sub>sd</sub> Source-Drain Voltage (V)

Figure 8: V<sub>gs</sub> Gate-Source Voltage (V)

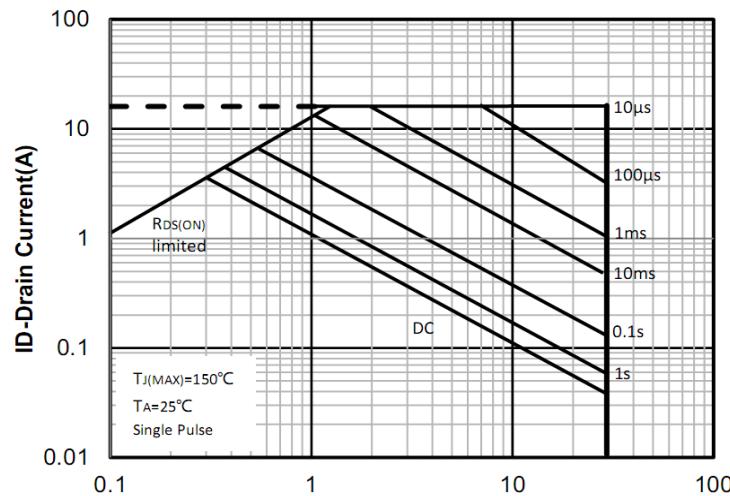


Figure 9: V<sub>ds</sub> Drain -Source Voltage (V)

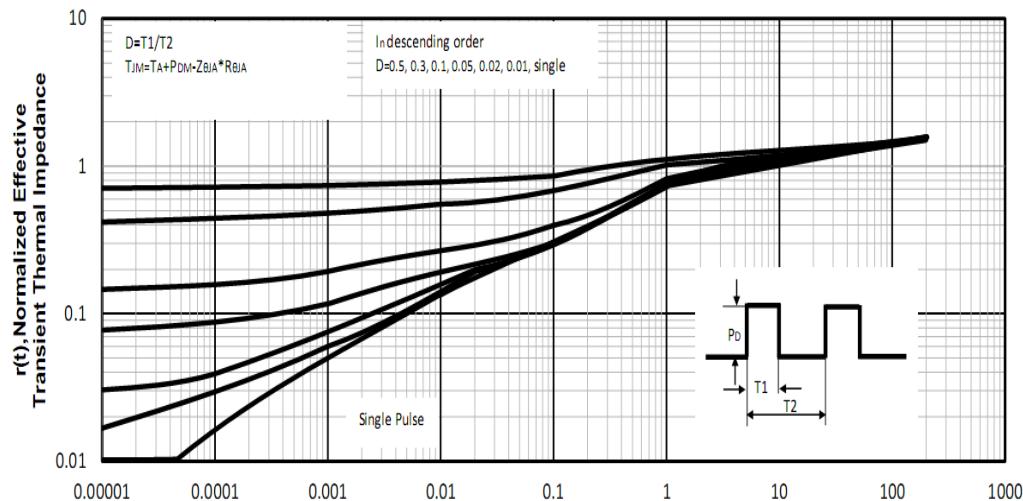


Figure 10: Square Wave Pulse Duration (sec)

**30V/3.5A N-Channel Enhancement Mode MOSFET  
Test Circuit and Waveform:**

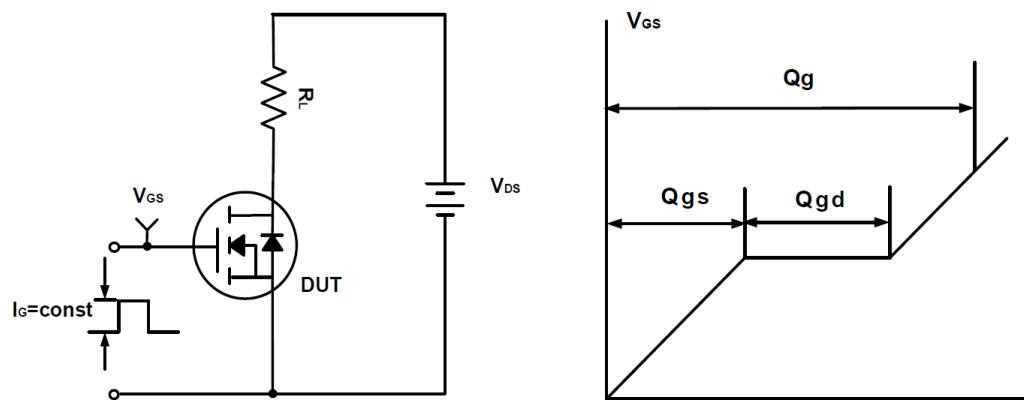


Figure A Gate Charge Test Circuit &Waveforms

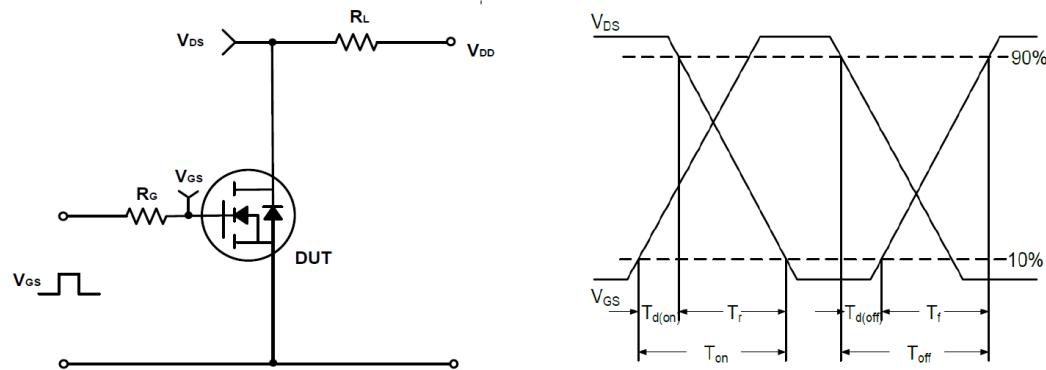


Figure B Switching Test Circuit & Waveforms

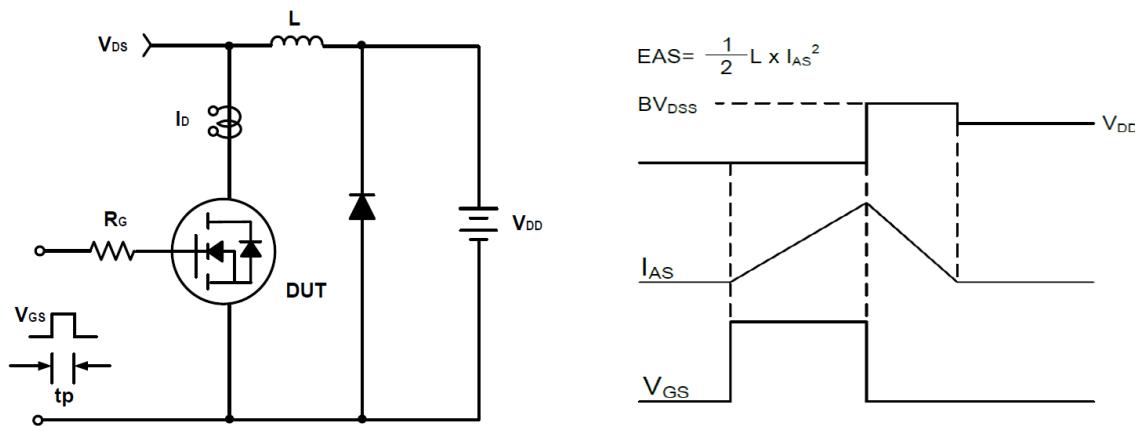
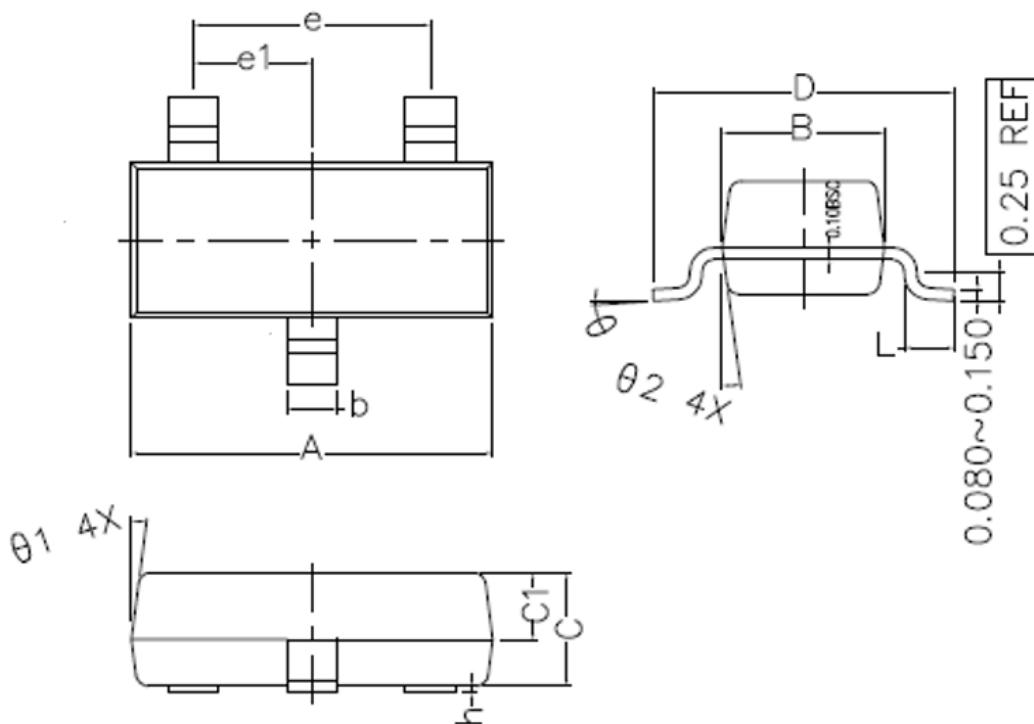


Figure C Unclamped Inductive Switching Circuit & Waveforms

**30V/3.5A N-Channel Enhancement Mode MOSFET**
**SOT-23 Package Outline Dimensions (Units: mm)**


COMMON DIMENSIONS (UNITS OF MEASURE IS mm)			
	MIN	NORMAL	MAX
A	2.800	2.900	3.000
B	1.200	1.300	1.400
C	0.900	1.000	1.100
C1	0.500	0.550	0.600
D	2.250	2.400	2.550
L	0.300	0.400	0.500
h	0.010	0.050	0.100
b	0.300	0.400	0.500
e	1.90 TYPE		
e1	0.95 TYPE		
θ <sub>1</sub>	7° TYPE		
θ <sub>2</sub>	7° TYPE		
θ	0° ~ 7°		